

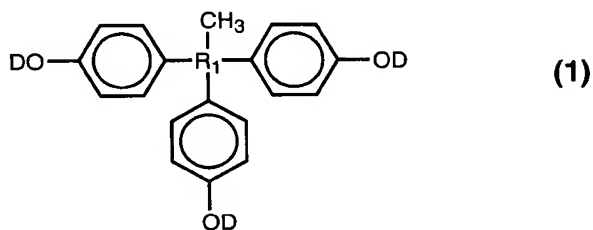
IN THE CLAIMS

Please amend the claims as follows:

Claim 1 (Currently Amended): A positive photosensitive resin composition comprising (A), (B) and (C);

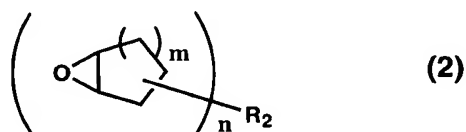
wherein (A) comprises an alkali-soluble resin comprising a copolymer comprising an unsaturated carboxylic acid derivative and an N-substituted maleimide selected from N-cyclohexylmaleimide, N-methylmaleimide and N-ethylmaleimide, and which has a number average molecular weight of from 2,000 to 20,000,

wherein (B) comprises a 1,2-quinone diazide compound of formula (1):



wherein each D independently is a hydrogen atom or an organic group comprising a 1,2-quinone diazide group, wherein R<sub>1</sub> is a tetravalent organic group, provided that at least one of D is an organic group comprising a 1,2-quinone diazide group, and

wherein (C) comprises a crosslinking compound represented by formula (2), which is present in from 5 to 50 parts by weight, per 100 parts by weight of the alkali-soluble resin,

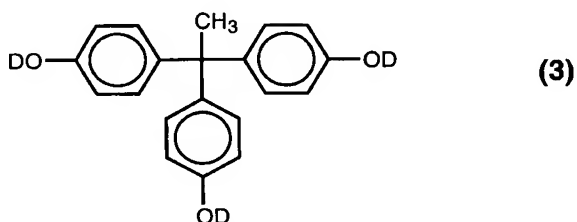


wherein n is an integer of from 2 to 10, m is an integer of from 0 to 4, and R<sub>2</sub> is an n-valent organic group.

Claim 2 (previously presented): The positive photosensitive resin composition of Claim 1, wherein the alkali-soluble resin comprises a residual monomer ratio of at most 2.5 wt%.

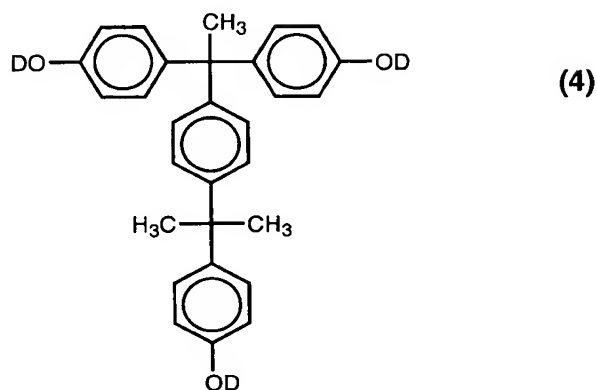
Claim 3 (previously presented): The positive photosensitive resin composition of Claim 1, comprising the 1,2-quinone diazide compound in an amount of from 5 to 100 parts by weight, per 100 parts by weight of the alkali-soluble resin.

Claim 4 (previously presented): The positive photosensitive resin composition of Claim 1, wherein the 1,2-quinone diazide compound is a compound of formula (3):



wherein each D independently is a hydrogen atom or an organic group comprising a 1,2-quinone diazide group, provided that at least one of D is an organic group comprising a 1,2-quinone diazide group.

Claim 5 (previously presented): The positive photosensitive resin composition of Claim 1, wherein the 1,2-quinone diazide compound is a compound of formula (4):



wherein each D independently is a hydrogen atom or an organic group comprising a 1,2-quinone diazide group, provided that at least one of D is an organic group comprising a 1,2-quinone diazide group.

Claim 6 (previously presented): The positive photosensitive resin composition of Claim 1, wherein the alkali-soluble resin does not comprise an epoxy group.

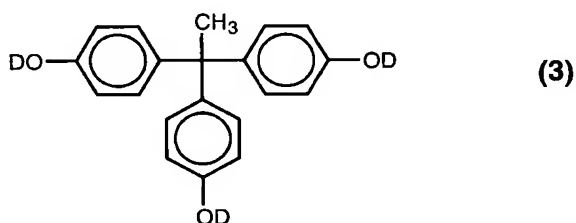
Claim 7 (previously presented): The positive photosensitive resin composition of Claim 1, wherein n is an integer of from 3 to 10, and m is an integer of 2, in the crosslinking compound of formula (2).

Claim 8 (previously presented): The positive photosensitive resin composition of Claim 1, further comprising a surfactant in an amount of from 0.01 to 5 parts by weight per 100 parts by weight of the alkali-soluble resin.

Claim 9 (previously presented): The positive photosensitive resin composition of Claim 1, wherein the positive photosensitive resin composition is a solution comprising a solid content concentration of from 1 to 50 wt%.

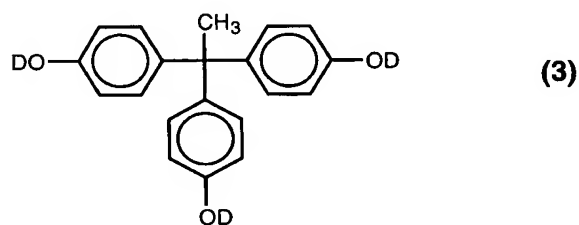
Claim 10 (previously presented): The positive photosensitive resin composition of Claim 2, comprising the 1,2-quinone diazide compound in an amount of from 5 to 100 parts by weight, per 100 parts by weight of the alkali-soluble resin.

Claim 11 (previously presented): The positive photosensitive resin composition of Claim 2, wherein the 1,2-quinone diazide compound is a compound of formula (3):



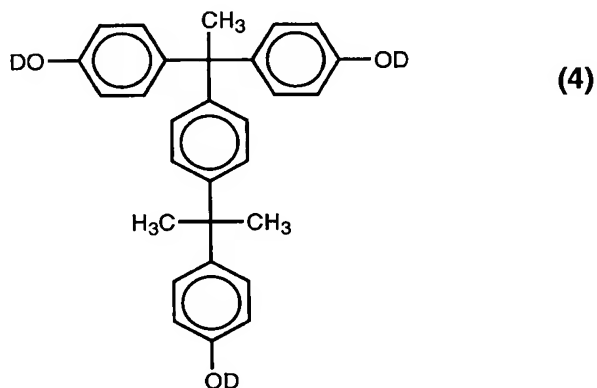
wherein each D independently is a hydrogen atom or an organic group comprising a 1,2-quinone diazide group, provided that at least one of D is an organic group comprising a 1,2-quinone diazide group.

Claim 12 (previously presented): The positive photosensitive resin composition of Claim 3, wherein the 1,2-quinone diazide compound is a compound of formula (3):



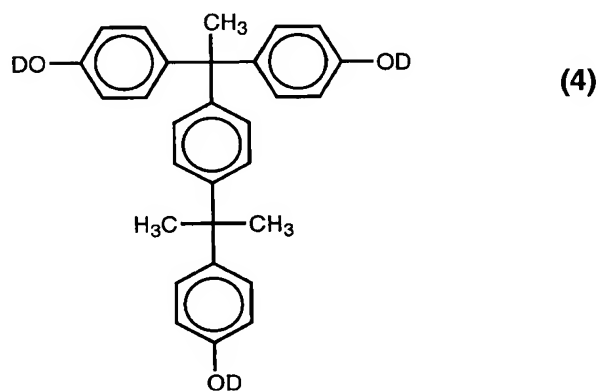
wherein each D independently is a hydrogen atom or an organic group comprising a 1,2-quinone diazide group, provided that at least one of D is an organic group comprising a 1,2-quinone diazide group.

Claim 13 (previously presented): The positive photosensitive resin composition of Claim 2, wherein the 1,2-quinone diazide compound is a compound of formula (4):



wherein each D independently is a hydrogen atom or an organic group comprising a 1,2-quinone diazide group, provided that at least one of D is an organic group comprising a 1,2-quinone diazide group.

Claim 14 (previously presented): The positive photosensitive resin composition of Claim 3, wherein the 1,2-quinone diazide compound is a compound of formula (4):



wherein each D independently is a hydrogen atom or an organic group comprising a 1,2-quinone diazide group, provided that at least one of D is an organic group comprising a 1,2-quinone diazide group.

Claim 15 (previously presented): The positive photosensitive resin composition of Claim 2, wherein n is an integer of from 3 to 10, and m is an integer of 2, in the crosslinking compound of formula (2).

Claim 16 (previously presented): The positive photosensitive resin composition of Claim 3, wherein n is an integer of from 3 to 10, and m is an integer of 2, in the crosslinking compound of formula (2).

Claim 17 (previously presented): The positive photosensitive resin composition of Claim 4, wherein n is an integer of from 3 to 10, and m is an integer of 2, in the crosslinking compound of formula (2).

Claim 18 (previously presented): The positive photosensitive resin composition of Claim 5, wherein n is an integer of from 3 to 10, and m is an integer of 2, in the crosslinking compound of formula (2).

Claim 19 (previously presented): The positive photosensitive resin composition of Claim 2, further comprising a surfactant in an amount of from 0.01 to 5 parts by weight per 100 parts by weight of the alkali-soluble resin.

Claim 20 (previously presented): The positive photosensitive resin composition of Claim 3, further comprising a surfactant in an amount of from 0.01 to 5 parts by weight per 100 parts by weight of the alkali-soluble resin.